

Small Signal Schottky Diode



SOT-323

Features

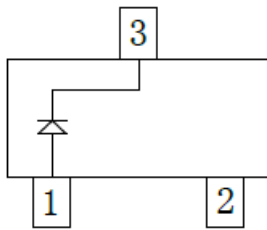
- Epoxy meets UL-94 V-0 flammability rating and halogen free
- Moisture Sensitivity Level 1
- Low Forward Voltage Schottky Rectifier
- V_{RRM} 40V
- I_{FAV} 0.12A
- Part no. with suffix "Q" means AEC-Q101 qualified

Applications

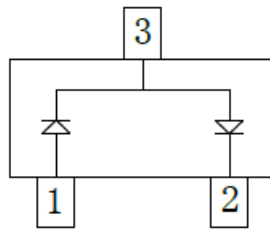
- Ultra high speed switching
- Voltage clamping

Mechanical Data

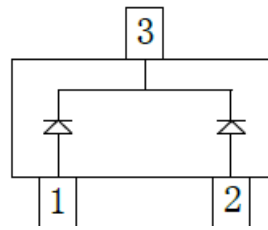
- **Case:** SOT-323
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102



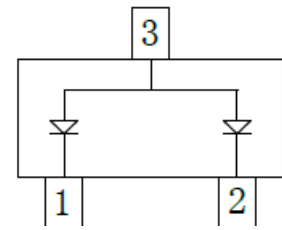
BAS40WTQ
Marking:43



BAS40WT-04Q
Marking:44



BAS40WT-05Q
Marking:45



BAS40WT-06Q
Marking:46

■ Maximum Ratings ($T_a=25^\circ\text{C}$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	CONDITIONS	VALUE
Peak Repetitive Reverse Voltage	V_{RRM}	V		40
Average Forward Current	I_{FAV}	mA		120
Non-repetitive Peak Forward Surge Current	I_{FSM}	A	square wave $t_p < 10\text{ms}$	0.6
Power Dissipation	P_D	mW		200
Thermal Resistance Junction to Ambient	R_{thJA}	$^\circ\text{C}/\text{W}$		500
Junction Temperature	T_j	$^\circ\text{C}$		-55 to +150
Storage Temperature Range	T_{stg}	$^\circ\text{C}$		-55 to +150



BAS40WTQ THRU BAS40WT-06Q

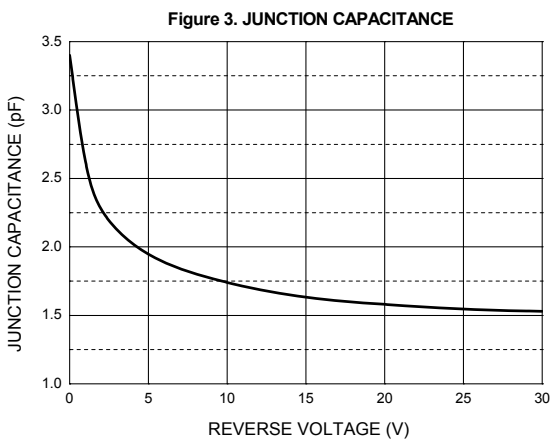
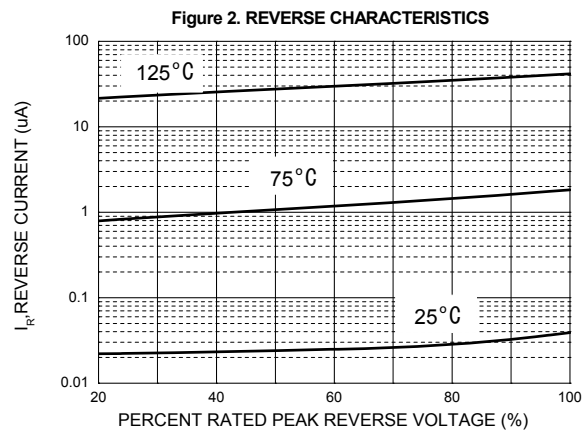
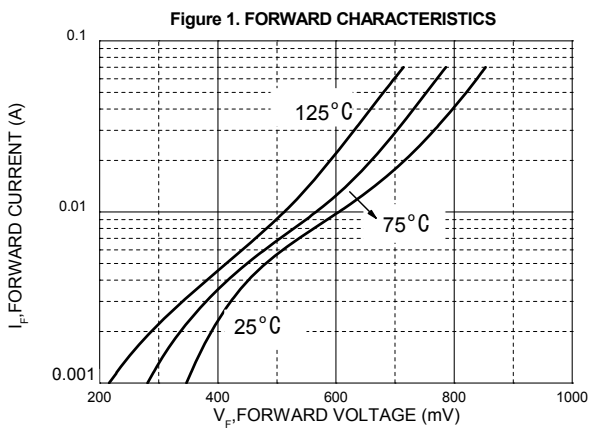
■ Electrical Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	CONDITIONS	MIN	MAX
Reverse Breakdown Voltage	V _{(BR)R}	V	I _R =10uA	40	
Forward Voltage	V _F	V	I _F =1.0mA	-	0.38
			I _F =40mA	-	1.0
Reverse Current	I _R	μA	V _R =30V	-	0.2
Junction Capacitance	C _J	pF	V _R =0 V, f =1MHz	-	5
Reverse Recovery Time	t _{rr}	ns	I _F =I _R =5mA, I _{tr} =0.5mA, R _L =100Ω	-	5

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
BAS40WTQ BAS40-04WTQ BAS40-05WTQ BAS40-06WTQ	F2	Approximate 0.006	3000	30000	120000	7" reel

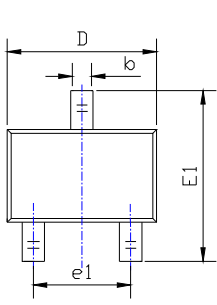
■ Characteristics(Typical)



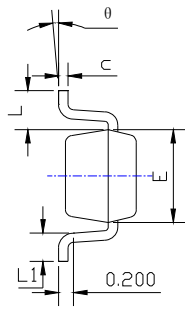


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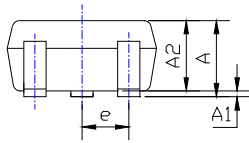
■SOT-323 Package Outline Dimensions



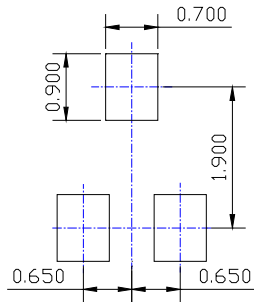
TOP VIEW



SIDE VIEW



SIDE VIEW



UNIT: mm

SUGGESTED SOLDER PAD LAYOUT

SYMBOL	DIMENSIONS			
	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.035	0.043	0.900	1.100
A1	0.000	0.004	0.000	0.100
A2	0.035	0.039	0.900	1.000
b	0.006	0.016	0.150	0.400
c	0.004	0.010	0.100	0.250
D	0.071	0.087	1.800	2.200
E	0.045	0.053	1.150	1.350
E1	0.085	0.096	2.150	2.450
e	0.026 TYP		0.650 TYP	
e1	0.047	0.055	1.200	1.400
L	0.021 REF		0.525 REF	
L1	0.010	0.018	0.260	0.460
θ	0°	8°	0°	8°

NOTE:

- 1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
- 2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.
- 3.THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.



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